

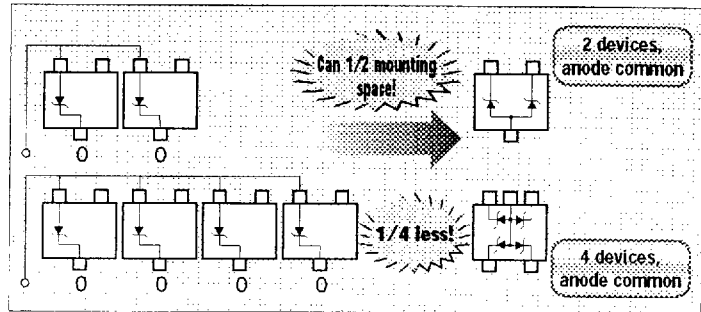
Introducing small complex zener diodes

4 devices
in one package

These are perfect for ESD protection for high speed data communication

For these reasons this can solve your problems

1. External surges cause the circuit to move and ICs to break
2. Can reduce PCB space and number of parts necessary
3. Can reduce cost

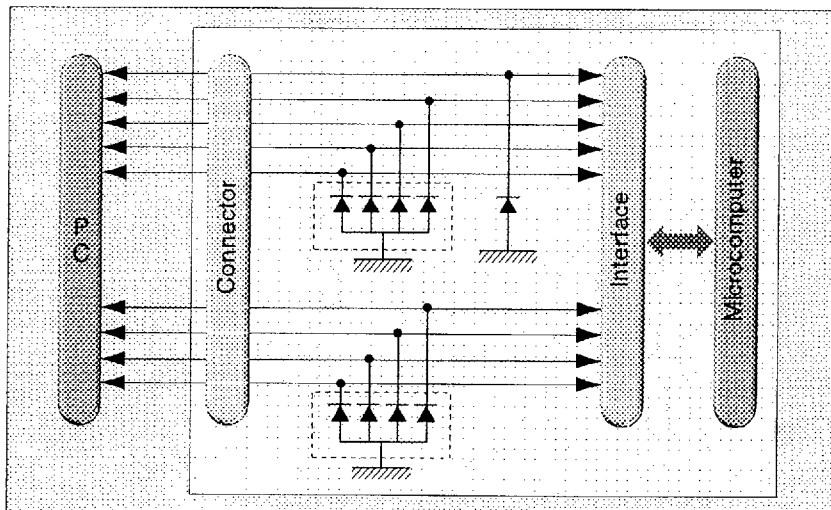


We guarantee these parts against 8KV of ESD based on the IEC1000-4-2 ESD test

Line up Ultra-lander Development

Part number	Internal circuit	Package
UMZ 6.8E		UMD5(2012)
FTZ 5.6E		SMD5(2916)
FTZ 6.8E		
FTZ 12E		
STZ 5.6N		SMD3(2916)
STZ 6.2N		
STZ 6.8N		
EMZ 6.8N		EMD3(1608)
UMZ 6.8N		UMD3(2012)
UMZ 8.2N		
UMZ 12N		
STZ 6.8T		SMD3(2916)
UMZ 8.2T		UMD3(2012)

Example of an actual circuit



Zener diode (Silicon Epitaxial Planer)

UMZ 6.8E

APPLICATION

Voltage regulation(Common anode)

FEATURE

- Small mold type (UMD5)
- Low Ct

Mass per piece

6.8mg/pcs

ABSOLUTE MAXIMUM RATING(Ta=25°C)

Characteristic	Symbol	Limits
Power dissipation *	P	200mA
Junction temperature	Tj	150°C
Storage temperature	Tstg	-55~150°C

* Total four elements

ELECTRICAL CHARACTERISTIC(Ta=25°C)

Characteristic	Symbol	Test condition	Standard	
			Min.	Max.
Zener voltage	VZ	IZ=5mA	6.47V	7.14V
Reverse current	IR	VR=3.5V	—	0.5μA
Dynamic impedance	ZZ	IZ=5mA	—	40Ω

*Please pay attention to static electricity when handling.

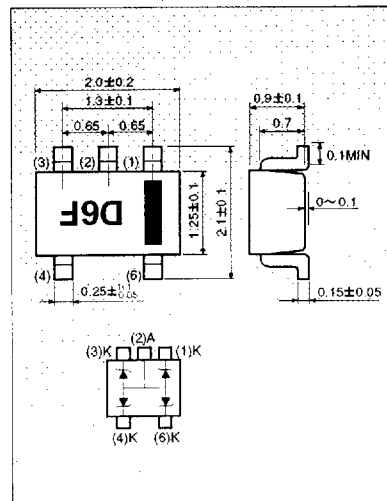
OTHER

Characteristic	Standard 1	IEC-1000-4-2
Equipment	Charge/discharge Capacitance : 200pF ±10%	Charge/discharge Capacitance : 150pF
Composition	Discharge resistance : 400Ω ±10%	Discharge resistance : 330Ω
Criterion	Repeat by 5 times	Repeat by 10 times
	No combustion and smoking : ±25KV	No erroneous operation
	No element destruction : ±20KV	Contact : ±5KV
	No erroneous operation : ±8KV	In air : ±1KV

Characteristic	Test condition	Typical Data
Junction Capacitance	f=1MHz, VR=5V	9pF

Low Ct

DIMENSION(UNIT:mm)



Zener diode (Silicon Epitaxial Planer)

EMZ 6.8N

APPLICATION

Voltage regulation(Common anode)

FEATURE

- Ultra small mold type (EMD3)
- Low Ct

Mass per piece

2mg/pcs

ABSOLUTE MAXIMUM RATING(Ta=25°C)

Characteristic	Symbol	Limits
Power dissipation *	P	200mA
Junction temperature	Tj	150°C
Storage temperature	Tstg	-55~150°C

* Total four elements

ELECTRICAL CHARACTERISTIC(Ta=25°C)

Characteristic	Symbol	Test condition	Standard	
			Min.	Max.
Zener voltage	VZ	IZ=5mA	6.47V	7.14V
Reverse current	IR	VR=3.5V	—	0.5μA
Dynamic impedance	ZZ	IZ=5mA	—	40Ω

*Please pay attention to static electricity when handling.

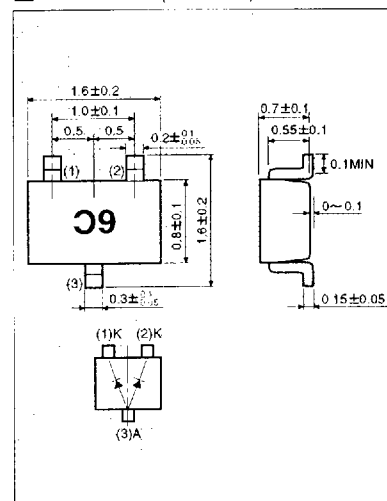
OTHER

Characteristic	Standard 1	IEC-1000-4-2
Equipment	Charge/discharge Capacitance : 200pF ±10%	Charge/discharge Capacitance : 150pF
Composition	Discharge resistance : 400Ω ±10%	Discharge resistance : 330Ω
Criterion	Repeat by 5 times	Repeat by 10 times
	No combustion and smoking : ±25KV	No erroneous operation
	No element destruction : ±20KV	Contact : ±5KV
	No erroneous operation : ±8KV	In air : ±1KV

Characteristic	Test condition	Typical Data
Junction Capacitance	f=1MHz, VR=5V	9pF

Low Ct

DIMENSION(UNIT:mm)



Zener diode (Silicon Epitaxial Planer)

UMZ 6.8N

APPLICATION

Voltage regulation
(Common anode dual chip)

FEATURE

- Small mold type (UMD3)
- Low Ct

Mass per piece

6mg/pcs

ABSOLUTE MAXIMUM RATING(Ta=25°C)

Characteristic	Symbol	Limits
Power dissipation *	P	200mA
Junction temperature	Tj	150°C
Storage temperature	Tstg	-55~150°C

* Total four elements

ELECTRICAL CHARACTERISTIC(Ta=25°C)

Characteristic	Symbol	Test condition	Standard	
			Min.	Max.
Zener voltage	VZ	IZ=5mA	6.47V	7.14V
Reverse current	IR	VR=3.5V	—	0.5μA
Dynamic impedance	ZZ	IZ=5mA	—	40Ω

*Please pay attention to static electricity when handling.

OTHER

Characteristic	Standard 1	IEC-1000-4-2
Equipment	Charge/discharge Capacitance : 200pF ±10%	Charge/discharge Capacitance : 150pF
Composition	Discharge resistance : 400Ω ±10%	Discharge resistance : 330Ω
Criterion	Repeat by 5 times	Repeat by 10 times
	No combustion and smoking : ±25KV	No erroneous operation
	No element destruction : ±20KV	Contact : ±5KV
	No erroneous operation : ±8KV	In air : ±1KV

Characteristic	Test condition	Typical Data
Junction Capacitance	f=1MHz, VR=5V	9pF

Low Ct

DIMENSION(UNIT:mm)

